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**SBR3U60P1** 

#### 3A SBR SUPER BARRIER RECTIFIER **POWERDI**

## **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F</sub> Max (V)	I <sub>R</sub> Max (μA)	
60	3	0.65	100	

## **Description**

The SBR3U60P1 is a single rectifier in the POWERDI® 123 package, offering excellent high-temperature stability and low forward voltage.

## **Applications**

- **Bridge Diodes**
- Flyback Diodes
- **Blocking Diodes**
- Reverse Protection Diodes

#### **Features and Benefits**

- Ultra Low Forward Voltage Drop
- Low Reverse Leakage Current
- Patented Super Barrier Rectifier SBR® Technology
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (SBR3U60P1Q)

#### **Mechanical Data**

- Case: POWERDI123
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.018 grams (Approximate)

#### POWERDI123





Top View

Device Symbol

# **Ordering Information** (Note 4)

Part Number	Compliance	Case	Packaging
SBR3U60P1-7	AEC-Q101	POWERDI123	3,000/Tape & Reel
SBR3U60P1-13	AFC-Q101	POWERDI123	10.000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



## **Marking Information**



3U6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2014		2015	20	16	2017		2018	2	2019
Code	Υ		В		С		)	Е		F		G
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

### **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$		
Working Peak Reverse Voltage	$V_{RWM}$	60	V
DC Blocking Voltage	$V_{RM}$		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42	V
Average Rectified Output Current	Io	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	80	А
Repetitive Peak Avalanche Energy (1µs, +25°C)	P <sub>ARM</sub>	2,100	W

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Soldering (Note 5) Thermal Resistance Junction to Ambient (Note 6)	$R_{ heta JS} \ R_{ heta JA}$	5 175	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

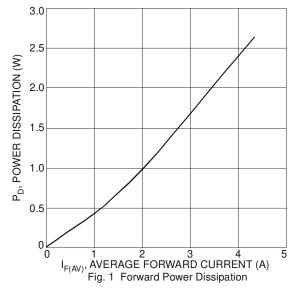
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	$V_{F}$	_	1	0.650	٧	$I_F = 3.0A, T_J = +25$ °C
Leakage Current (Note 7)	I <sub>R</sub>	_	_	100	μΑ	$V_R = 60V, T_J = +25^{\circ}C$

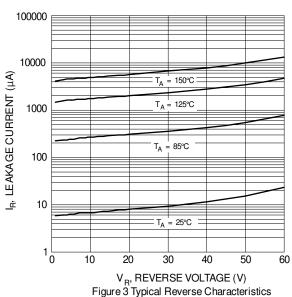
Notes:

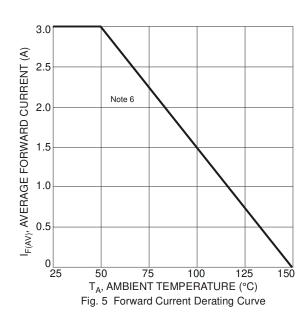
- 5. Theoretical R<sub>BJS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 6. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.

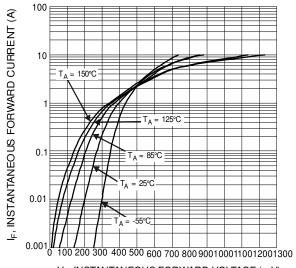




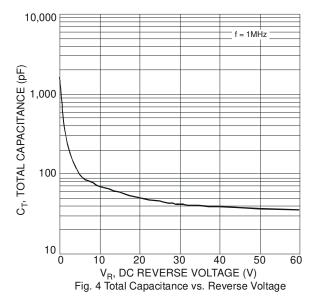








 $\label{eq:VF} V_{\text{F}}, \text{INSTANTANEOUS FORWARD VOLTAGE (mV)} \\ \text{Figure 2 Typical Forward Characteristics}$ 



150
(C)
Wat 125
Wat 12



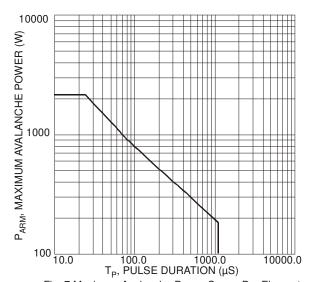


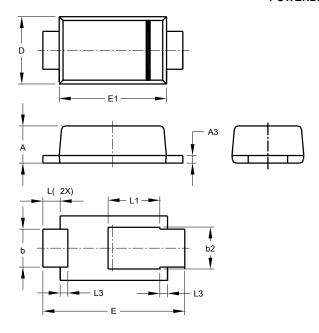
Fig. 7 Maximum Avalanche Power Curve, Per Element



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### POWERDI123

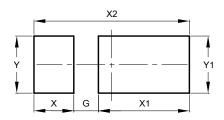


POWERDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### POWERDI123



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Υ	1.50
Y1	1.50



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